

Hi3516C V200 Economical HD IP Camera SoC

Brief Data Sheet

Issue 02

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HiSilicon Technologies Co., Ltd.

Huawei Industrial Base Address:

> Bantian, Longgang Shenzhen 518129

People's Republic of China

Website: http://www.hisilicon.com

Email: support@hisilicon.com



Key Specifications

Processor Core

• ARM926@600 MHz, 32 KB I-cache, 32 KB D-cache

Video Encoding

- H.264 main/high profile L4.0
- H.264 baseline encoding
- MJPEG/JPEG baseline encoding

Video Encoding Performance

- A maximum of 2-megapixel resolution for H.264 encoding
- Real-time H.264 & JPEG encoding of multiple streams: 1080p@30 fps+VGA@30 fps+1080p@1 fps JPEG snapshot
- 2 megapixels@5 fps JPEG snapshot
- CBR or VBR with the output bit rate ranging from 2 kbit/s to 100 Mbit/s
- Encoding frame rate ranging from 1/16 fps to 30 fps
- Encoding of eight ROIs
- OSD overlaying of eight regions before encoding

Intelligent Video Analysis

 Integrated IVE, supporting various intelligent analysis applications such as motion detection, perimeter defense, and video diagnosis

Video and Graphics Processing

- Video pre-processing, including 3D denoising, image enhancement, and edge enhancement
- Anti-flicker for output videos and graphics
- 1/15x to 16x video scaling
- 1/2x to 2x graphics scaling
- OSD overlaying of eight regions before encoding
- Hardware graphics overlaying for videos at the video layer and graphics layer 1 during post-processing

ISP

- 2x2 Pattern RGB-IR sensor
- Adjustable 3A (AE, AF, and AWB) functions
- Highlight compensation, backlight compensation, gamma correction, and color enhancement
- Defect pixel correction, denoising, and digital image stabilization
- Anti-fog
- Lens distortion correction
- Picture rotation by 90° or 270°
- Mirroring and flipping
- Build-in WDR and tone mapping
- ISP tuning tools for the PC

Audio Encoding/Decoding

- Voice encoding/decoding complying with multiple protocols by using software
- G.711, ADPCM, and G.726 protocols supported
- Echo cancellation, noise suppression, and automatic gain

Security Engine

- AES, DES, 3DES, and RSA encryption/decryption algorithms implemented by hardware
- Hash digest tamper proofing implemented by hardware
- Integrated 512-bit OTP storage space and hardware random number generator

Video Interfaces

- VI interfaces
 - 8-, 10-, 12-, or 14-bit RGB Bayer/RGB-IR inputs, maximum clock frequency of 100 MHz
 - BT.601, BT.656, and BT.1120 VI interfaces
 - 4-Lane MIPI/HiSPI/LVDS VI interfaces
 - Compatibility with mainstream HD CMOS sensors provided by Sony, Aptina, OmniVision, and Panasonic
 - Various sensor levels supported
 - Programmable sensor clock output
 - Maximum input resolution of 2 (1920*1080) megapixels
- VO interfaces
 - One BT.656 VO interface supporting 8-bit serial LCD outputs

Audio Interfaces

- Integrated audio CODEC that supports 16-bit audio inputs and outputs
- Mono-channel differential microphone input for reducing the background noises
- Single-end input
- I²S input

Peripheral Interfaces

- POR
- One integrated high-precision RTC
- One 4-channel SAR ADC
- Three UART interfaces
- IR interfaces, I²C interfaces, SPI master interfaces, and GPIO interfaces
- Four PWM interfaces
- Two SDIO interfaces, one of which supports SD 3.0
- One USB 2.0 interface that supports the host/device mode
- RMII in 10/100 Mbit/s full-duplex or half-duplex mode, TSO network acceleration, and PHY clock output

External Memory Interfaces

- DDR interface
 - 16-bit DDR2/DDR3/DDR3L interface
 - Maximum frequency of 400 MHz
 - Maximum capacity of 4 Gbits
- SPI NOR flash interface
 - 1-, 2-, or 4-bit SPI NOR flash interface
- SPI NAND flash interface
 - Maximum capacity of 4 Gbits
- eMMC 5.0 interface



- Maximum capacity of 64 GB
- Booting from the SPI NOR flash, SPI NAND flash, or eMMC

SDK

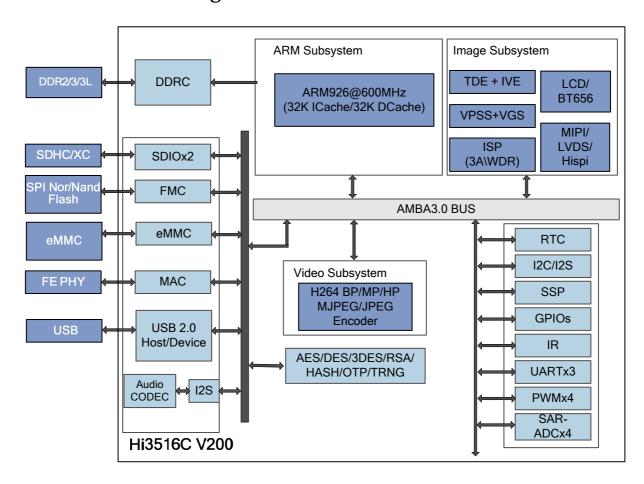
- Linux 3.4-based SDK
- High-performance H.264 PC decoding library

Physical Specifications

- Power consumption
 - Typical power consumption of 700 mW
 - Multi-level power saving mode
- Operating voltages
 - 1.1 V core voltage
 - 3.3 V I/O voltage and 3.8 V margin voltage
- Package
 - Body size of 12 mm x 12 mm (0.47 in. x 0.47 in.),
 0.65 mm (0.03 in.) ball pitch, TFBGA RoHS package with 273 pins



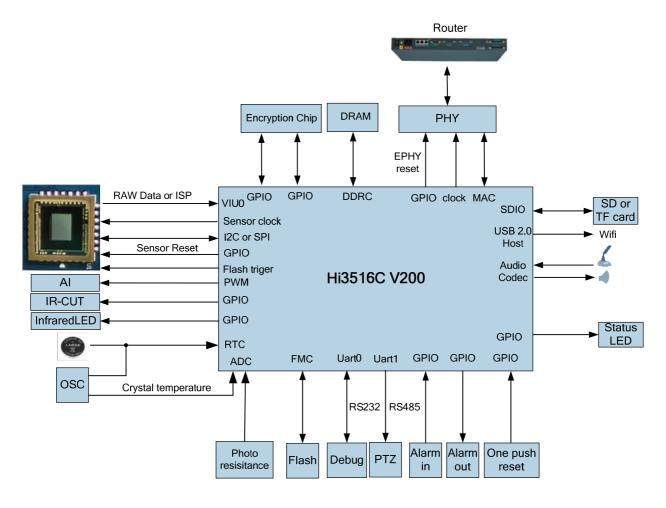
Functional Block Diagram



Hi3516C V200 is a new-generation SoC designed for the HD IP camera. It has an integrated new-generation ISP and H.264 encoder. It uses the optimized picture processing algorithm before encoding, advanced low-power technology, and low-power architecture design. These designs and functions enable Hi3516C V200 to feature industry-leading low bit rate, high picture quality, and low power consumption. It supports 90° or 270° rotation and lens distortion correction by using hardware, which meets requirements in various surveillance application scenarios. It also supports 3A algorithms, which allow customers to design various types of IP cameras including the movement of the integrated camera. Hi3516C V200 integrates the POR, RTC as well as audio CODEC and supports various sensor levels and clock outputs, which significantly reduces the EBOM costs for the Hi3516C V200 HD IP camera. Similar to other HiSilicon DVR and NVR SDKs, the Hi3516C V200 SDK supports rapid mass production and the system layout of IP cameras, DVRs, and NVRs.



Hi3516C V200 Economical HD IP Camera Solution





Acronyms and Abbreviations

3DES triple data encryption standard

ADPCM adaptive differential pulse code modulation

AE automatic exposure

AES advanced encryption standard

AF automatic focus

AWB automatic white balance

CBR constant bit rate
CODEC coder/decoder

DDR double data rate

DES data encryption standard

DVR digital video recorder

EBOM engineering bill of materials

eMMC embedded multimedia card

GPIO general-purpose input/output

HD high definition

HiSPI high-speed serial pixel interface

I²C inter-integrated circuit

I²S inter-IC sound

IR infrared

ISP image signal processor

IVE intelligent video engine

LCD liquid crystal display

LVDS low-voltage differential signaling

MIPI mobile industry processor interface

NVR network video recorder

OSD on-screen display

OTP one-time programming

POR power-on reset

PWM pulse-width modulation



RGB red-green-blue

RMII reduced media independent interface

RoHS Restriction of Hazardous Substances

ROI region of interest

RSA Rivest-Shamir-Adleman

RTC real-time clock

SAR ADC successive approximation register analog-to-digital converter

SDIO secure digital input/output

SDK software development kit

SDRAM synchronous dynamic random access memory

SoC system-on-chip

SPI serial peripheral interface

TFBGA thin & fine-pitch ball grid array

TSO TCP segmentation offload

UART universal asynchronous receiver transmitter

VBR variable bit rate

VI video input

VO video output

WDR wide dynamic range